

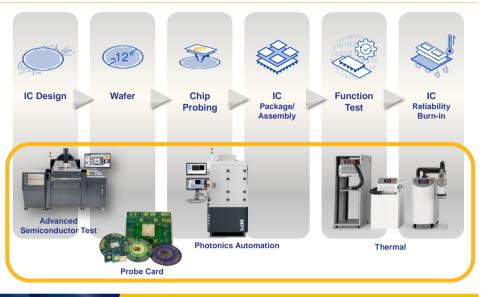
Presentation Disclaimer

The information herein contains forward-looking statements. We have based these forward-looking statements on our current expectations and projections about future events. Although we believe that these expectations and projections are reasonable, such forward-looking statements are inherently subject to risks, uncertainties and assumptions about us, including, among other things: the intensely competitive Semi-conductor, and LED industries and markets; Cyclical nature of the semiconductor industry; Risks associated with global business activities; General economic and political conditions. All financial figures discussed herein are prepared pursuant to IFRS. All audited figures will be publicly announced upon the completion of our audited process.





MPI-The Powerhouse of Testing Solutions



MPICORPORATION

READY FOR THE TEST™

6

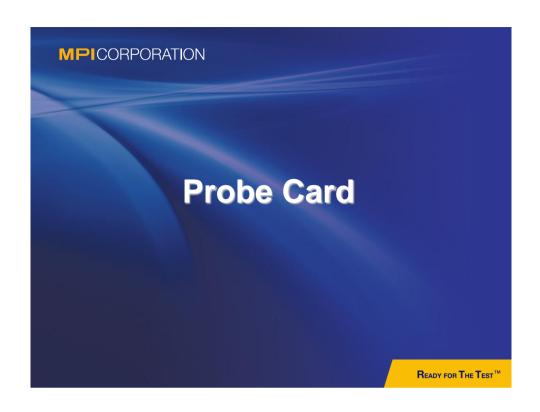
Agenda

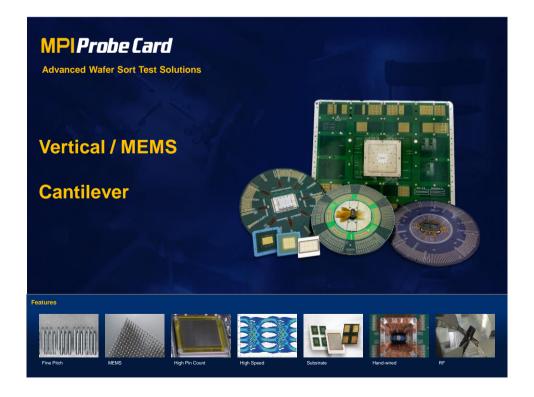


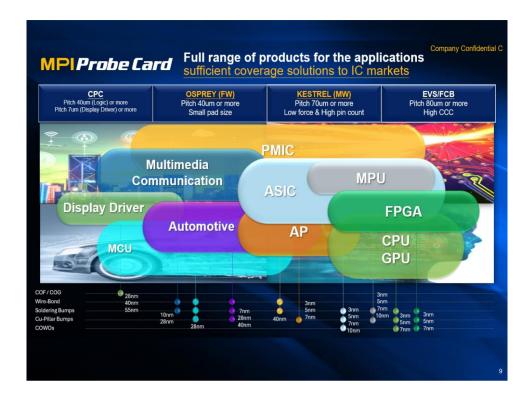
Business Contents

Probe Card
Photonics Automation
Thermal & AST

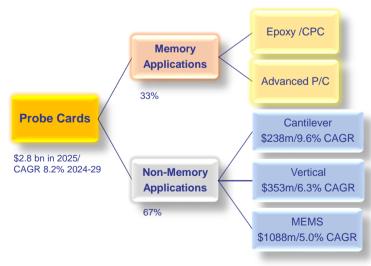








Global Probe Card Market Update



Total Own Make IC Probe Cards Venders

(Rank)		2020	2021	2022	2023	2024
FormFactor	USA	1	1	1	1	1
Technoprobe	Italy	2	2	2	2	2
Micronics Japan	Japan	3	3	3	3	3
MPI Corporation	Taiwan	5	5	5	4	4
Japan Electronic Materials	Japan	4	4	4	5	5

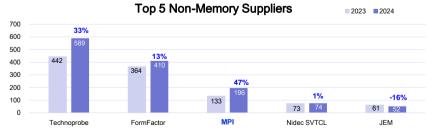


MPICORPORATION

Ready for The Test $^{\mathsf{TM}}$

Top 5 Non-Memory Probe Card Vendors

(Rank)		2020	2021	2022	2023	2024
Technoprobe	Italy	2	1	1	1	1
FormFactor	USA	1	2	2	2	2
MPI Corporation	Taiwan	3	3	3	3	3
Nidec SV Probe	Singapore	4	5	4	4	4
Japan Electronic Materials	Japan	5	4	5	5	5



Source: TechInsights

Probe Card: Total Solution Provider

Comprehensive Product Range for Circuit Testing

全方位的產品布局

MPI provides omnidirectional products to global customers, including fine pitch CPC, high speed VPC and low force MEMS solutions.

● Solid Global Clientele 堅實的國際合作夥伴

MPI works closely with worldwide market leaders, especially for the AI, HPC application related.

● Complete Probe Card Solution 完整的探針卡整合方案

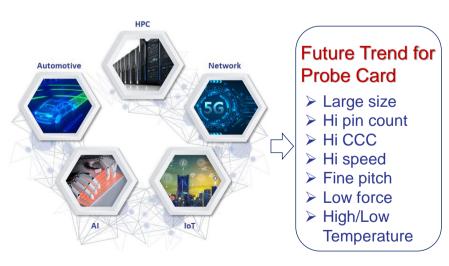
Provide <u>probe head</u>, <u>substrate</u>(MLO/MLC/MLOC) and <u>PCB</u> one-stop service.

MPICORPORATION

Ready for The Test $^{\text{TM}}$

13

Fast Growing Applications



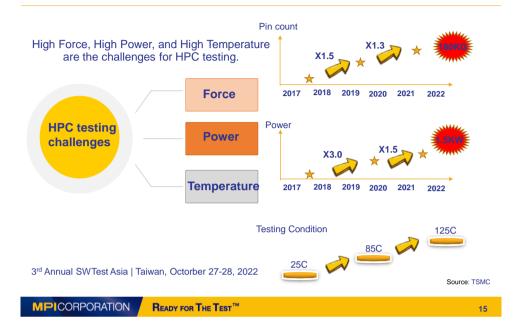
Source: TSMC

MPICORPORATION

READY FOR THE TESTTM

Company Confidential B

HPC Challenges



Interface Technical Complexity Check in

Complexity Trends are on pace to be at 2022 targets(1 Cycle) or in some cases beyond

"2x4 Scaling"=2xPins, 2xPerformance, every 4 years



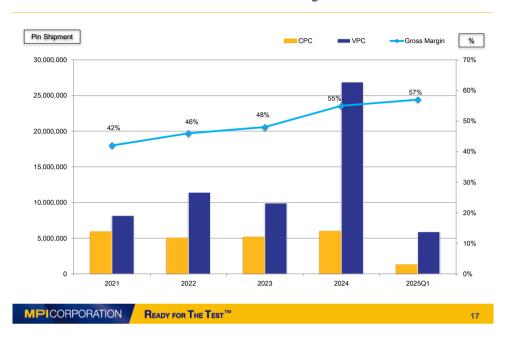
		2018	2022	2026	
		Level 4	Level 5	Level 6	
	Pin Pitch	90um	70um	50um	
Pin Density	Total Contact Force	80kg	150kg	250kg	
I/O Chand	Digital	32Gpbs	64Gpbs	128Gpbs	
I/O Speed	I/O Speed RF/mmWave		29 GHz	+60 GHz	
	Main Power	900 mV	750mV	625mV	
Device Power Single Rail Impedance		35A	50A	100A	
		2.2 mOhm	1.4 mOhm	0.8 mOhm	
	Self Heating	75 W			
Thermal	Operating Range	0 to +80C	0 to +105C	-20 to +125C	
	t Expensive robe Card	\$400K*	>\$500K	>\$700K	

Source:Teradyne

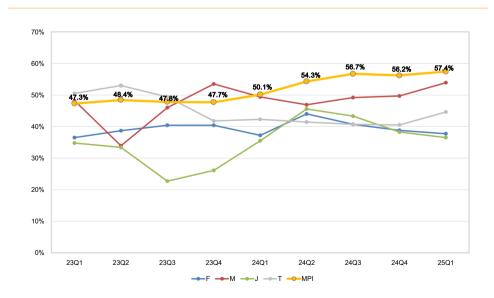
MPICORPORATION

READY FOR THE TEST™

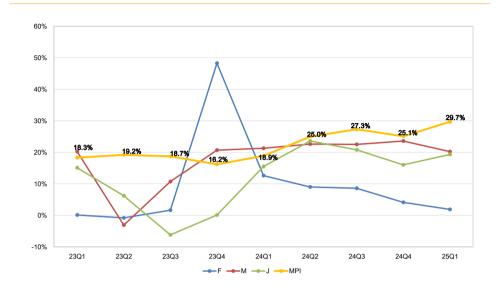
CPC and VPC Yearly Status



Gross Margin Between Global Peers



Operating Margin Between Global Peers

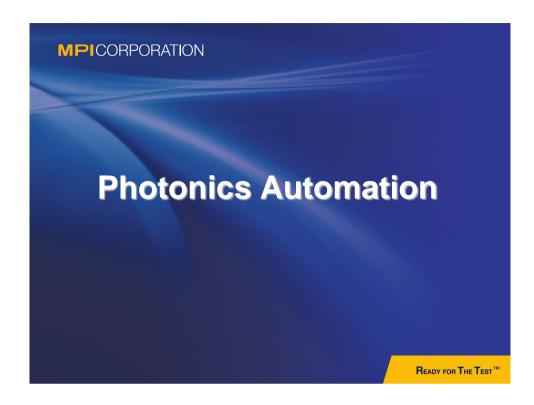


MPICORPORATION

Ready for The Test $^{\mathsf{TM}}$

19





Product Portfolio and Capability



- High Power VCSEL Wafer Testing Wafer / Board Prober Development Testing methodology Development
- High Power VCSEL PKG Testing PKG Handler Development Testing methodology Development
- VCSEL/ Photo-Detector Testing Wafer/ Board Prober Development Testing methodology Development
- Wafer Level RF Testing Integration
- SiPh Die/PKG Platform SiPh Handler Development
- > uLED Mass Production Methodology
 Wafer prober for large quantity die testing method
- > Panel testing platform development
 Panel / Panel in-process testing platform

Development Plan by Application







Optical Sensing	Optical Communications	Micro Display
 Focus on Sensing VCSEL Testing Production Wafer Prober in Low Temperature High Power Measurement Tool and Technology Development Flip Chip Wafer VCSEL testing Solution Package / Hybrid Device testing tool 	 Focus on VCSEL/Photodetector Testing Wafer Prober for Dark / Responsivity / Capacity measurement RF Measurement Capability Development SiPh package testing approaching 	 Lab and production wafer testing tool development Contacting Accuracy Improvement Innovative testing methodology Optical measurement in production methodology

MPICORPORATION

Ready for The Test $^{\mathsf{TM}}$

23

PA: Work With Market Leaders

● Value Enhanced Product Lines 客戶價值導向的產品線規劃

MPI's experienced RD team comes across <u>lighting</u> and <u>electrical</u> fields with <u>automation</u> core technology that enables us to develop leading market solutions ie VCSEL & Micro LED.

● Solid Global Clientele 穩固的全球客戶群

MPI works closely with market leaders and international brand names for most advanced testing solutions.

● Continuous Product Innovation 持續的產品創新

Non stop RD investments helps MPI to provide high value added products that tackles clients' testing bottleneck.





Thermal: Customer Focus

- Innovational Temperature System 創新的溫度測試系統 Ongoing R&D investments in platforms and improvements leads MPI to meet customer demands. Thermal systems have a number of patents to provide efficient energy saving products that helps clients to fulfill ESG responsibility.
- Top Skillful RD Team 頂尖優秀專業的研發團隊

MPI's thermal solutions are developed by industry veterans with over 100 years of combined experience.

 Deep Cooperation with Leading Customers for Engineering and Production demand

與世界領導級大廠深度合作,提供工程及量產需求

Product application expands to automotive, 5G/RF communication, fiber optic, and sensing fields.

MPICORPORATION

Ready for The Test $^{\text{TM}}$

27



AST: Unique Market Leader

● Unique Global Position 全球獨特的市場地位

Combining Analytical probing solution and RF measurement core technology, MPI is top solution provider for full range hi-frequency response measurement.

● VOC Design 客戶導向設計

Design based on Voice of the customer to full-fill customers' needs.

● Complete Solution 提供完整的解決方案

Various series of products to cover wide range applications include Device Modeling, RF & mmW, WLR, High-Power, Failure Analysis, Extreme temperature test ...etc.

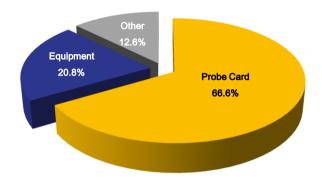
MPICORPORATION

READY FOR THE TEST™

29



2025 Q1 Shipment Breakdown

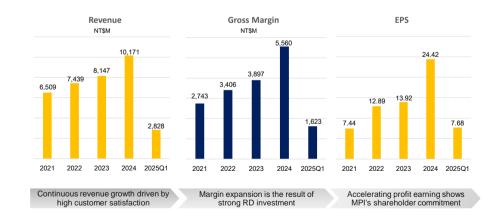


MPICORPORATION

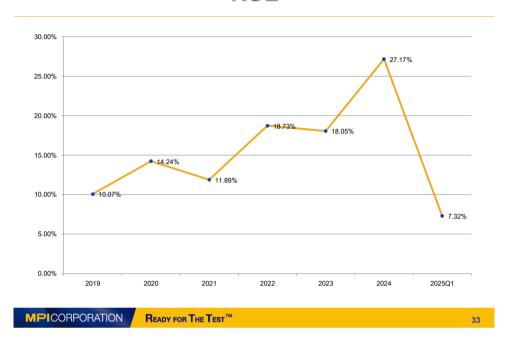
Ready for The Test $^{\text{TM}}$

31

Solid Performance



ROE



Balance Sheet Highlight

NT\$M	2025Q1		2024Q1		
Cash and Cash Equivalents	5,965	31%	2,546	20%	
Fixed Assets	7,640	39%	5,669	45%	
Total Assets	19,536	100%	12,565	100%	
LT Debt	945	5%	1,453	12%	
Shareholders' Equity	10,456	54%	8,206	65%	
EBITDA	887	31%	482	23%	

*EBITDA=operating income + depreciation & amortization expenses

P&L

NT\$000	2025Q1		2024Q1		
Net Sales	2,828,698	100%	2,046,692	100%	
Cost of Goods Sold	1,205,368	43%	1,020,800	50%	
Gross Profit	1,623,330	57%	1,025,892	50%	
Operating Expense	782,986	27%	639,117	32%	
Operating Income	840,344	30%	386,775	18%	
Investment Income & Others	47,380		95,592		
Net Income (after tax)	723,042	26%	392,927	19%	
EPS (after tax)	7.68		4.18		
IPICORPORATION Ready for The Test™					

